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## **PACKAGING INFORMATION**

| Orderable Device | Status  | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| SG2524D          | ACTIVE  | SOIC         | D                  | 16   | 40             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -25 to 85    | SG2524                  | Samples |
| SG2524DR         | ACTIVE  | SOIC         | D                  | 16   | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -25 to 85    | SG2524                  | Samples |
| SG2524DRE4       | ACTIVE  | SOIC         | D                  | 16   | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -25 to 85    | SG2524                  | Samples |
| SG2524DRG4       | ACTIVE  | SOIC         | D                  | 16   | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -25 to 85    | SG2524                  | Samples |
| SG2524N          | ACTIVE  | PDIP         | N                  | 16   | 25             | RoHS & Green | NIPDAU                        | N / A for Pkg Type | -25 to 85    | SG2524N                 | Samples |
| SG3524D          | LIFEBUY | SOIC         | D                  | 16   | 40             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | SG3524                  |         |
| SG3524DR         | ACTIVE  | SOIC         | D                  | 16   | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | SG3524                  | Samples |
| SG3524DRE4       | ACTIVE  | SOIC         | D                  | 16   | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | SG3524                  | Samples |
| SG3524N          | ACTIVE  | PDIP         | N                  | 16   | 25             | RoHS & Green | NIPDAU                        | N / A for Pkg Type | 0 to 70      | SG3524N                 | Samples |
| SG3524NE4        | ACTIVE  | PDIP         | N                  | 16   | 25             | RoHS & Green | NIPDAU                        | N / A for Pkg Type | 0 to 70      | SG3524N                 | Samples |
| SG3524NSR        | ACTIVE  | SO           | NS                 | 16   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | SG3524                  | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



## **PACKAGE OPTION ADDENDUM**

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- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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